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RESINOID POCKETED CUTOFF AND GRINDING WHEEL AND METHOD OF MAKING SAME

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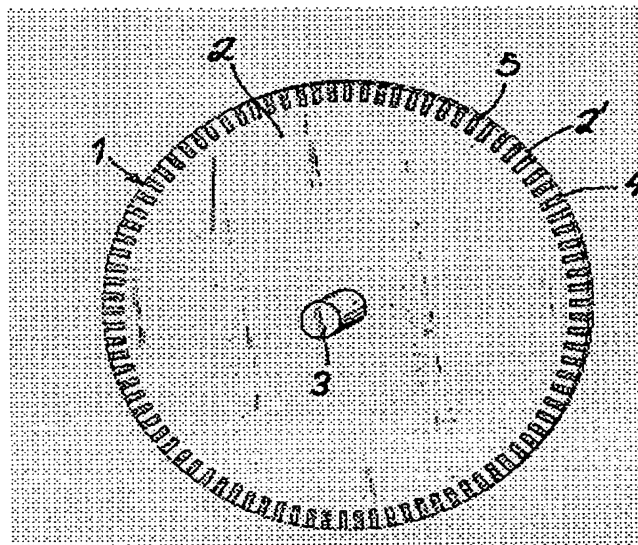
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Abstract of correspondent: **US3657845**

A cutoff or grinding wheel having a rotatable support, preferably in the form of a disk with a thickness of up to 1 mm, formed with a multiplicity of openings along the disk periphery. Diamond particles, with or without other abrasive, are incorporated in a resinous binder and are bonded thereby in the openings of the wheel. Diamond particles have a particle size up to 40 microns and the binder is resinified by prolonged heating.



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